Status of the Chinese Power Electronics Industry
WHAT IS IN THIS REPORT?

• Does China’s economy slow down have an impact on the power electronics market?

• What is the driver of Chinese power electronics market?

• Detailed description of different market sectors, including:
  • NEVs including BEV, PHEV and electric bus
  • Renewable energy sectors, including PV and Wind
  • Grid, traction, UPS and motor drive

• Description of the industrial landscape, local and foreign supplier

• Understand the market dynamics for the related power electronics applications

• Market projection for inverter market in different segments in China up to 2020
China is now the largest power electronic market in the world.
WHAT IS GOING TO DRIVE THE POWER ELECTRONIC MARKET IN CHINA?

- PV
- Wind
- Renewable Energy
- HVDC
- Industrialization
- Manufacturing/Equipment for the processing industry
- Grid
- Transportation
- High Speed Railway
- Public transport: Tram, Metro
- NEV
The inverter market for traction is going to reach
China’s GDP and Growth Rate
From 2004 to 2014

- Since initiating market reforms in 1978, China has witnessed impressive growth. China is now the second largest economy in the world by nominal GDP and now the accounted for 13.3% of global gross domestic product in 2014 from less than 5% a decade earlier.
• Car manufacturers – NEV manufacturers are mainly concentrated in the east of China.
There are numerous HVDC projects in China

## LIST OF COMING HVDC PROJECTS ALREADY PROVED BY THE GOVERNMENT

### 2015-2020

<table>
<thead>
<tr>
<th>Country</th>
<th>Name</th>
<th>Voltage (kV)</th>
<th>Power (GW)</th>
<th>Length (km)</th>
<th>Date</th>
<th>Supplier</th>
<th>Type</th>
</tr>
</thead>
<tbody>
<tr>
<td>China</td>
<td>Humeng-Shandong</td>
<td>800</td>
<td>6.4</td>
<td></td>
<td>2015</td>
<td></td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>Xiluodo-Hanzhou</td>
<td>800</td>
<td>6.4</td>
<td></td>
<td>2015</td>
<td></td>
<td>LCC</td>
</tr>
<tr>
<td>Russia/China</td>
<td>Irkutsk-Beijing</td>
<td>800</td>
<td>6.4</td>
<td></td>
<td>2015</td>
<td></td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>Ningdong-Zhejiang</td>
<td>800</td>
<td>8</td>
<td>1720</td>
<td>2016</td>
<td>ABB</td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>guanyinyan HVDC project</td>
<td>500</td>
<td>3</td>
<td>577</td>
<td>2016</td>
<td>ABB</td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>Shanghaimiao-Shandong</td>
<td>660 or 800</td>
<td>10</td>
<td>1239.4</td>
<td>2016</td>
<td></td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>Jinsha River II - East China</td>
<td>800</td>
<td>6.4</td>
<td></td>
<td>2016</td>
<td></td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>Goupitan-Guangdong</td>
<td>500</td>
<td>3</td>
<td></td>
<td>2016</td>
<td></td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>Ximeng-Taizhou</td>
<td>800</td>
<td>10</td>
<td>1619.7</td>
<td>2017</td>
<td></td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>Shanxi-Nanjing</td>
<td>800</td>
<td>8</td>
<td>1118</td>
<td>2017</td>
<td></td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>Jiuquan-Hunan</td>
<td>800</td>
<td>8</td>
<td>2445</td>
<td>2017</td>
<td></td>
<td>LCC</td>
</tr>
<tr>
<td>China</td>
<td>Dianxibei-Guangdong</td>
<td>800</td>
<td>5</td>
<td>1928</td>
<td>2017</td>
<td></td>
<td>LCC</td>
</tr>
</tbody>
</table>

• Chinese government has given significant funding to WBG development and industrialization. Since 2006, several companies have gradually entered WBG field. Chinese companies cover the entire value chain from WBG material to devices.

• As in other countries, different factors are going to contribute to market dynamics and influence the market adoption of WBG power devices and the WBG industry. But China will try to not be lagging behind.

China is trying to cover the entire value chain of WBG devices.
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Expiration date:

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